
RZ/T1 Group
CMSIS-RTOS RTX for Cortex-R4 Sample Programs V1.00
Release NoteR01AN3541EJ0100
Rev.1.00
2017.03.27

(for use with following combinations of environments and compilers:
EWARM and ICCARM, e2studio and Renesas GCC, DS-5 and ARMCC)

Introduction

This application note describes the package of “RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 Sample Programs V1.00” (hereinafter “RZ/T1_RTX”).

Operation Check Boards

RZ/T1 Evaluation Board (RTK7910018C00000BE)

History of Changes to the Previous Versions

Ver.	No.	Type	Description	Remarks
V1.00	-	-	First Release	-

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1. Package Contents

This package contains the following items:

1.1 Software

- Source codes

No.	Name	Folder Name
1	RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 Sample Programs V1.00	RZT1_CMSIS_RTOS_RTX

1.2 Documents

- Release Note and Application Note

No.	Title	Rev	File Name
1	RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 Sample Programs V1.00 Release Note	1.00	r01an3541ej0100_rzt1.pdf
2	RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 RTX Sample Programs Application Note	1.00	r01an3538ej0100_rzt1.pdf
3	RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 CMT(W) & ELC & ADC Sample Programs Application Note	1.00	r01an3539ej0100_rzt1.pdf
4	RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 MTU3a Sample Program Application Note	1.00	r01an3540ej0100_rzt1.pdf

1.3 Driver for USB Serial Conversion IC

- This driver is a driver for PC. It is used to connect PC and RZ/T1 Evaluation board(J8) with USB serial cable.

2. Folder Structure

Below is the folder structure for this package and details about its contents.

Top	
—Documentation	
—ReleaseNote	: Release Note (see Section on 1.2)
—Specification	: Application Notes (see Section on)
—Software	
—RZT1_CMSIS_RTOS_RTX	: A set of programs (see Section on 1.1)
—USB_serial_driver	: Driver for USB Serial Conversion IC
—readme_J.txt	: Readme documentation of this package (Japanese)
—readme_E.txt	: Readme documentation of this package (English)

3. Related Documents

- CMSIS-RTOS compliant Kernel Version 4.74
This is the specification for RTOS for use in this system. The sample application uses the functions of the RTX CMSIS-RTOS. Each sample application initializes the RTX CMSIS-RTOS.
- RZ/T1 Group User's Manual: Hardware (R01UH0483)
This document describes the hardware specifications of RZ/T1 devices.
Download the latest version from the Renesas Electronics website.
- Application Note: RZ/T1 Group Initial Settings (R01AN2554)
This document describes the initial settings for RZ/T1 devices.
Download the latest version from the Renesas Electronics website.
- Technical Update and Technical News
Download the latest version from the Renesas Electronics website.
- User's manuals related to the development environment

The latest version of the IAR integrated development environment (IAR Embedded Workbench for ARM) is available from the IAR Systems website.

The latest version of the DS-5 integrated development environment (ARM Development Studio 5) is available from the ARM website.

The latest version of the Renesas Electronics software development tools (e2studio, etc.) is available from the Renesas Electronics website.

4. How to use this package

4.1 Software information

- OS
CMSIS-RTOS compliant Kernel Version 4.74
- Drivers
ADC, CMT, ELC, MTU3
- Samples
FPU_ex1, mail, message RTX_CMT_ex1, RTX_ex2, RTX_MTU3_ex1, RTX_Traffic, Semaphore

4.2 Tools information

- Integrated Development Environment (One of the following)
 - Manufactured by IAR Systems : Embedded Workbench® for ARM Version 7.80.2
(hereinafter “EWARM”)
 - Manufactured by RENESAS : e2studio 5.2.0.020 (hereinafter “e2studio”)
 - Manufactured by ARM : DS-5 Version 5.22 (hereinafter “DS-5”)
- In-circuit Emulator
 - Manufactured by IAR Systems : I-jet JTAG emulator (in case of “EWARM”)
 - Manufactured by SEGGER : J-Link JTAG emulator (in case of “e2studio”)
 - Manufactured by ARM : KEIL ULINK2 emulator 5.22 (in case of “DS-5”)

4.3 Hardware information

- Device
RZ/T1
- Target Board
RZ/T1 Evaluation Board (RTK7910018C00000BE or RTK7910022C00000BR)

4.4 How to setup

About how to setup, refer to “Appendix1.Supplement on Development Environments” of
“Application Note: RZ/T1 Group Initial Settings (R01AN2554)”

5. Confirmation of sample program operation

About the operation of this package, refer to following application notes.

- RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 RTX Sample Programs (R01AN3538EJ)
- RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 CMT(W) & ELC & ADC Sample Programs (R01AN3539EJ)
- RZ/T1 Group CMSIS-RTOS RTX for Cortex-R4 MTU3a Sample Program (R01AN3540EJ)

6. Restrictions

No.	Type	Description
1	Multiple interrupts of SVC Handler	Do not allow multiple interrupts in SVC Handler. (The multiple interrupts are not allowed in SVC Handler at this package.)

7. Notes

No.	Type	Description
1	How to use "osThreadTermiate()" function	Do not call "osThreadTerminate()" function more than once with the same ThreadID.

8. Website and Support

- Renesas Electronics Website
<http://www.renesas.com/>
- Inquiries
<http://www.renesas.com/contact/>

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Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Mar 30, 2017	-	First Edition issued

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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